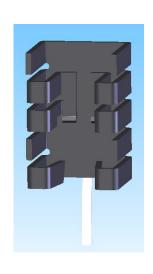
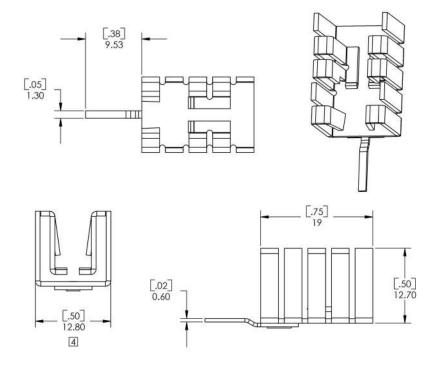
T0-220, T0-262

Board Level Heat Sinks



P/N: 831502B03900





PRODUCT SPECIFICATIONS -

• Devices: TO-220 & TO-262 • Size: 19.0 x 12.8 x 12.7 mm

Material: Aluminum, 1.2 mm Thick

Type: Stamped

• IC Mounting: Integrated Spring PCB Mounting: Solderable Tab

· Finish: Black Anodized

· Package: Bulk

FEATURES & BENEFITS

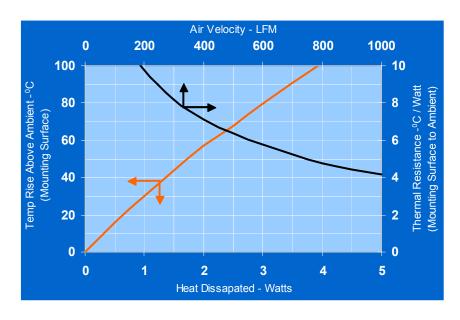
- No Hardware Device Attachment
- Constant Spring Force Tension
- · Vertical Mounting via Solderable Tab

RoHS Compliant



CUSTOMIZED HEATSINKS

- Specialized Tabs, Plating
- Specialized Body Configurations
- Contact Applications Engineering



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